

TOSHIBA Field Effect Transistor Silicon N Channel MOS Type (L²-π-MOSIII)

2SK1381

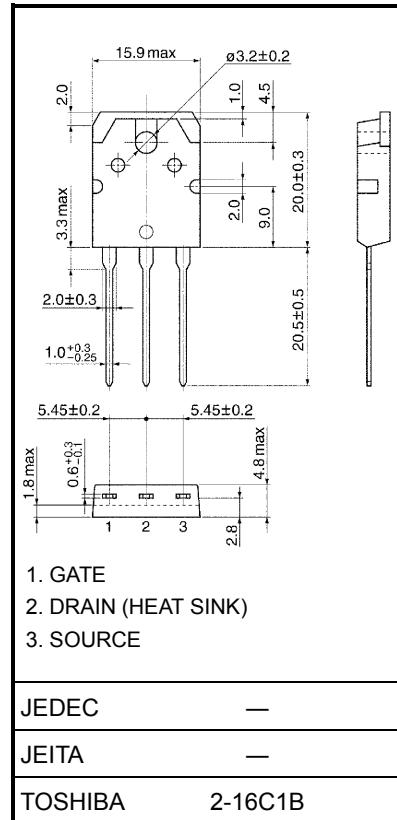
Relay Drive, Motor Drive and DC-DC Converter Applications

Unit: mm

- 4 V gate drive
- Low drain-source ON resistance : $R_{DS(ON)} = 25 \text{ m}\Omega$ (typ.)
- High forward transfer admittance : $|Y_{fs}| = 33 \text{ S}$ (typ.)
- Low leakage current : $I_{DSS} = 100 \text{ }\mu\text{A}$ (max) ($V_{DS} = 100 \text{ V}$)
- Enhancement-mode : $V_{th} = 0.8 \sim 2.0 \text{ V}$ ($V_{DS} = 10 \text{ V}$, $I_D = 1 \text{ mA}$)

Maximum Ratings ($T_a = 25^\circ\text{C}$)

Characteristics		Symbol	Rating	Unit
Drain-source voltage		V_{DSS}	100	V
Drain-gate voltage ($R_{GS} = 20 \text{ k}\Omega$)		V_{DGR}	100	V
Gate-source voltage		V_{GSS}	± 20	V
Drain current	DC (Note 1)	I_D	50	A
	Pulse (Note 1)	I_{DP}	200	
Drain power dissipation ($T_c = 25^\circ\text{C}$)		P_D	150	W
Channel temperature		T_{ch}	150	$^\circ\text{C}$
Storage temperature range		T_{stg}	-55~150	$^\circ\text{C}$



Weight: 4.6 g (typ.)

Thermal Characteristics

Characteristics	Symbol	Max	Unit
Thermal resistance, channel to case	$R_{th}(\text{ch-c})$	0.833	$^\circ\text{C} / \text{W}$
Thermal resistance, channel to ambient	$R_{th}(\text{ch-a})$	50	$^\circ\text{C} / \text{W}$

Note 1: Please use devices on condition that the channel temperature is below 150°C.

This transistor is an electrostatic sensitive device.

Please handle with caution.

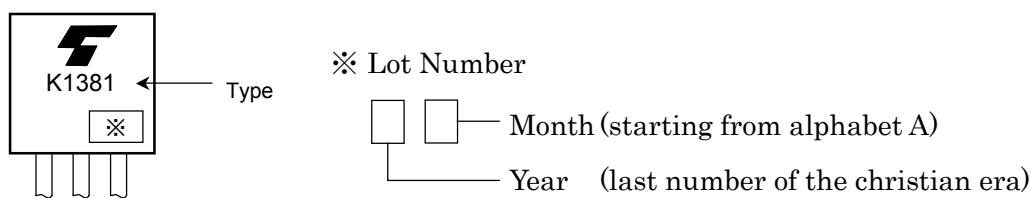
Electrical Characteristics (Ta = 25°C)

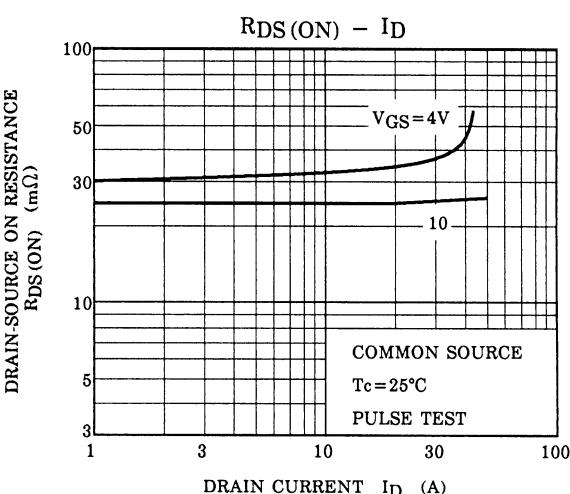
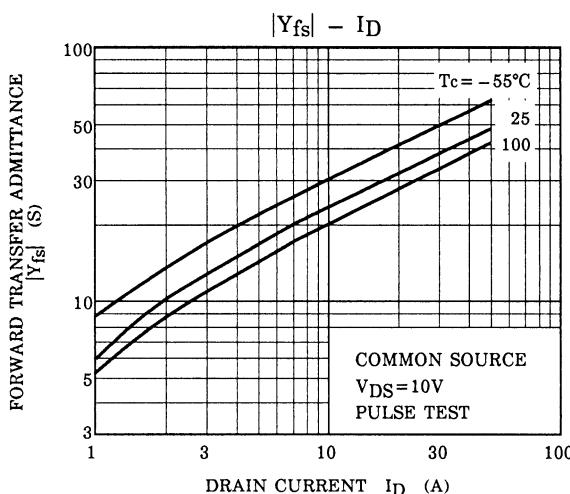
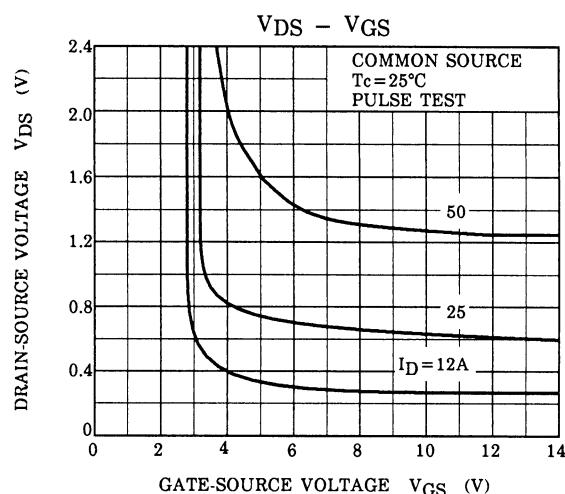
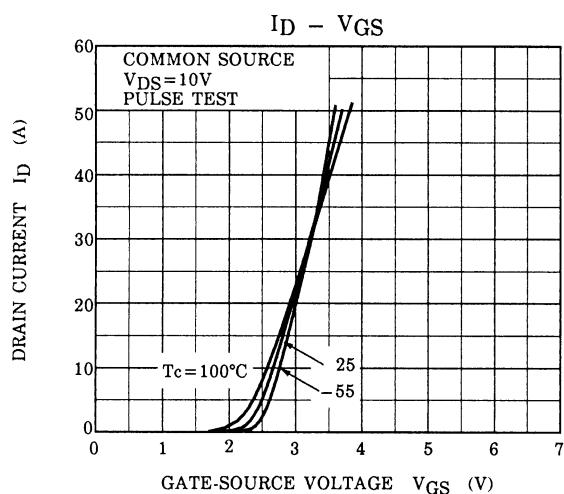
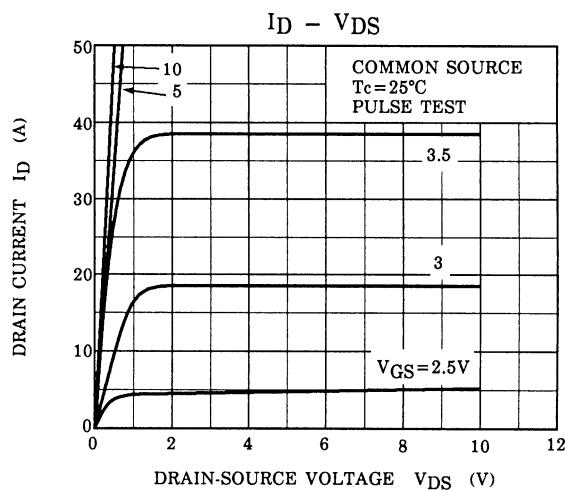
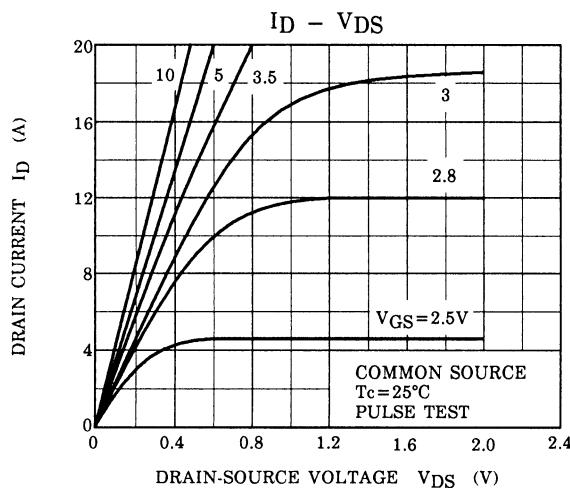
Characteristics	Symbol	Test Condition	Min	Typ.	Max	Unit
Gate leakage current	I _{GSS}	V _{GS} = ±20 V, V _{DS} = 0 V	—	—	±50	nA
Drain cut-off current	I _{DSS}	V _{DS} = 100 V, V _{GS} = 0 V	—	—	100	µA
Drain-source breakdown voltage	V (BR) DSS	I _D = 10 mA, V _{GS} = 0 V	100	—	—	V
Gate threshold voltage	V _{th}	V _{DS} = 10 V, I _D = 1 mA	0.8	—	2.0	V
Drain-source ON resistance	R _{DSS} (ON)	V _{GS} = 4 V, I _D = 25 A V _{GS} = 10 V, I _D = 25 A	— —	31 25	46 32	mΩ
Forward transfer admittance	Y _{fs}	V _{DS} = 10 V, I _D = 25 A	20	33	—	S
Input capacitance	C _{iss}	V _{DS} = 10 V, V _{GS} = 0 V, f = 1 MHz	—	3700	—	pF
Reverse transfer capacitance	C _{rss}		—	580	—	
Output capacitance	C _{oss}		—	1500	—	
Switching time	Rise time	t _r	 Duty $\leq 1\%$, $t_w = 10\mu s$	—	16	—
	Turn-on time	t _{on}		—	46	—
	Fall time	t _f		—	60	—
	Turn-off time	t _{off}		—	185	—
Total gate charge (Gate-source plus gate-drain)	Q _g	V _{DD} ≈ 80 V, V _{GS} = 10 V, I _D = 50 A	—	88	—	nC
Gate-source charge	Q _{gs}		—	62	—	
Gate-drain ("miller") charge	Q _{gd}		—	26	—	

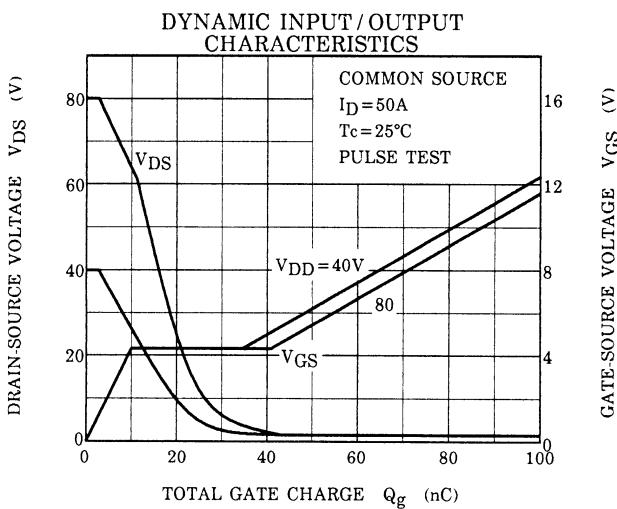
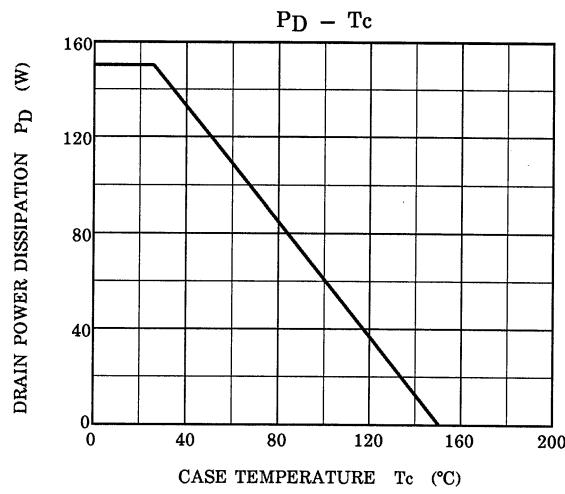
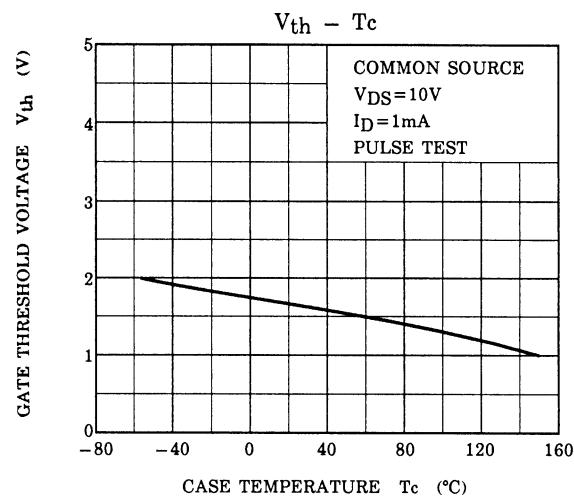
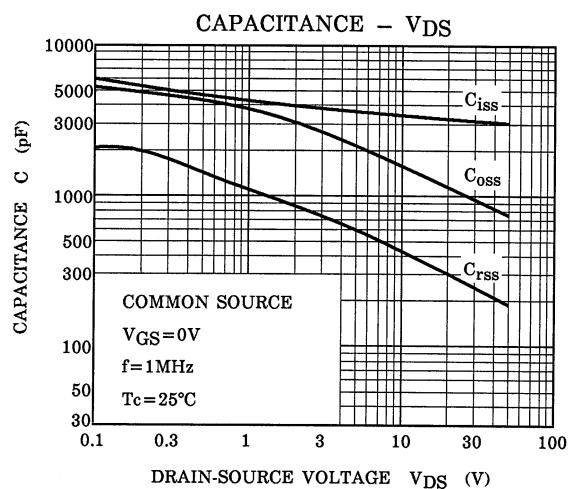
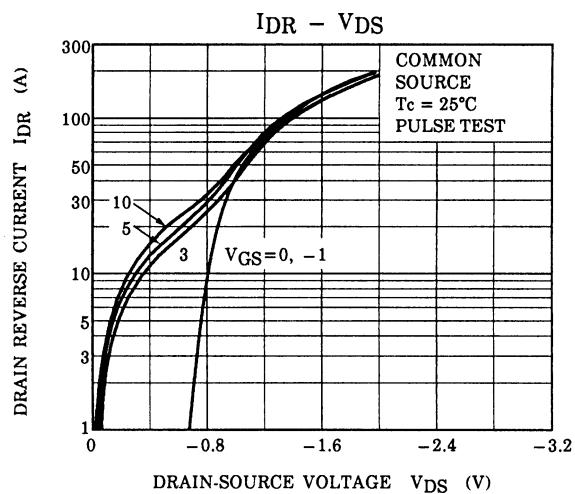
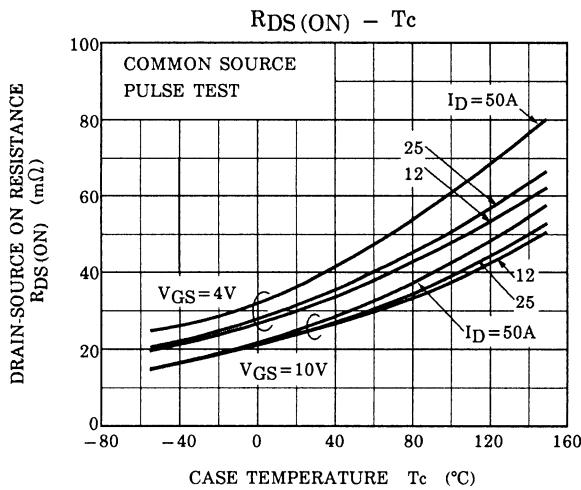
Source-Drain Ratings and Characteristics (Ta = 25°C)

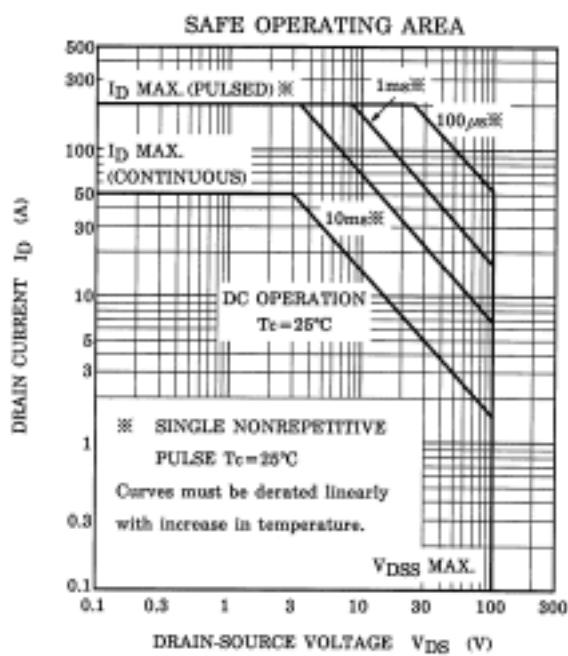
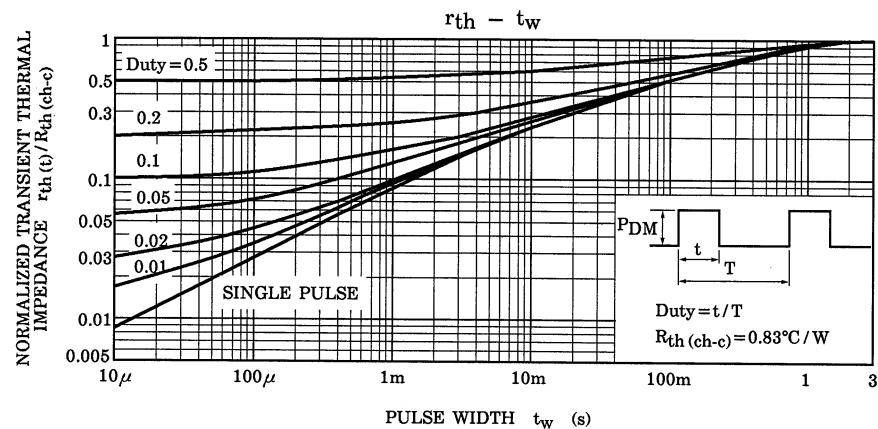
Characteristics	Symbol	Test Condition	Min	Typ.	Max	Unit
Continuous drain reverse current (Note 1)	I _{DR}	—	—	—	50	A
Pulse drain reverse current (Note 1)	I _{DRP}	—	—	—	200	A
Forward voltage (diode)	V _{DSF}	I _{DR} = 50 A, V _{GS} = 0 V	—	—	-1.6	V
Reverse recovery time	t _{rr}	I _{DR} = 50 A, V _{GS} = 0 V dI _{DR} / dt = 50 A / µs	—	280	—	ns
Reverse recovered charge	Q _{rr}		—	0.56	—	µC

Marking









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